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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/767,415	01/28/2004	Kuo Yi-Lung	23724-07791	2851
758	7590	03/31/2006	EXAMINER	
FENWICK & WEST LLP SILICON VALLEY CENTER 801 CALIFORNIA STREET MOUNTAIN VIEW, CA 94041			HOFFBERG, ROBERT JOSEPH	
			ART UNIT	PAPER NUMBER
			2835	

DATE MAILED: 03/31/2006

Please find below and/or attached an Office communication concerning this application or proceeding.



***Detailed Action***

***Claim Rejections - 35 USC § 102***

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

2. Claims 7-9 are rejected under 35 U.S.C. 102(e) as being anticipated by Rodriguez et al. (US 6,704,196).

With respect to Claim 7 and 9, Rodriguez et al. teaches an apparatus for cooling components on a motherboard of a personal computer, the apparatus comprising: a motherboard (see Fig. 1, CPU and Memory cards) containing a plurality of electronic components (see Fig. 1 CPU and memory) that generate heat (Col. 1, line 64) during operation, a high-heat subset (Col. 3, line 14) of the electrical components generating a relatively high amount of heat (Col. 3, lines 14-15 heat critical) and a low-heat subset (Col. 3, lines 10-11) of the electrical components generating a relatively low amount of heat (Col. 3, lines 10-11 less heat critical), and a chassis (Fig.1, #102) covering the motherboard and including a plurality of air outlets (see Fig. 1), wherein the air outlets are located closer to (see Fig. 1) the low-heat electrical components than to the high-heat electronic components, thereby generally directing heated exhaust air out of the chassis near the low-heat electrical components instead of near the high-heat electrical

components; a fan (see Fig. 1) mechanically coupled to the chassis and configured to direct an airflow (see Fig. 1) into the chassis to cool (Col. 1, lines 60-61) the electronic components on the motherboard. Rodriguez et al. further teaches wherein the fan is mounted on a wall (see Fig. 1) of the computer chassis. Rodriguez et al. further teaches a CPU mounted on the motherboard, wherein the fan is configured to blow air directly towards (Col. 3, lines 14-17) the CPU.

***Claim Rejections - 35 USC § 103***

3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

4. Claims 1-4 and 10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Rodriguez et al. (US 6,704,196) in view of Osborn et al. (US 6,034,870).

With respect to Claim 1 and 3, Rodriguez et al. teaches a cooling system for a personal computer, the cooling system comprising: a computer chassis (Fig.1, #102); a motherboard (see Fig. 1, CPU and Memory cards) mounted inside the computer chassis, the motherboard for coupling a number of electronic components (see Fig. 1 CPU and memory) that generate heat (Col. 1, line 64) during operation, and a fan (see Fig. 1) mechanically coupled to the computer chassis and configured to direct an airflow (see Fig. 1) through the fan, the air flow cooling (Col. 1, lines 60-62) the electronic components; wherein the computer chassis includes a plurality of air outlets (see Fig. 1) located far (see Fig. 1) from electronic components on the motherboard that generate a

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relatively large amount of heat (Col. 1, lines 60-61), thereby avoiding a hotter air flow near those components, and located near electrical components (see Fig.1 and Col. 1, line 61 memory) on the motherboard for which less heat dissipation (Col. 3, lines 10-11) is desired, thereby causing a hotter air flow (Col. 1, line 64) near those components. Rodriguez does not teach the airflow from outside the computer chassis to inside the computer chassis through the fan. Osborn et al. teaches the airflow (Fig. 3, #38) through the fan (Fig. 3, #36) from outside the computer chassis (Fig. 3, #12) to inside the computer chassis. Osborn et al. further teaches a motherboard (see Fig. 3) with a socket for receiving a CPU (Fig. 3, # 32); wherein the fan is configured to blow air directly towards (Fig. 3, #44) the socket from outside the computer chassis. It would have been obvious to one of ordinary skill in the art at the time of the invention was made to modify the system of Rodriguez et al. with that of Osborn et al. for the purpose of drawing air into the chassis close to where the most heat sensitive components including the CPU are located.

With respect to Claim 2, Rodriguez et al. further teaches wherein the fan is mounted on a wall (see Fig. 1) of the computer chassis.

With respect to Claim 4 and 10, Rodriguez et al. in view of Osborn et al. teaches the system and apparatus of claims 1 and 7, respectively above. Rodriguez et al. does not teach a filter. Osborn et al. teaches a filter (Fig. 3, #42) mounted in a path of an airflow (Fig. 3, #38) from the fan, the filter for removing particles from air outside the computer chassis before being blown inside the computer chassis. It would have been obvious to one of ordinary skill in the art at the time of the invention was made to modify

the system of Rodriguez et al. with that of Osborne et al. for the purpose of filtering the airflow to keep dust from inside the computer chassis.

***Response to Arguments***

5. The arguments of the appellant are not persuasive since the affidavit, as submitted on 14 March 2006, is not deemed effective to disqualify the Rodriguez et al. reference as prior art under 35 USC 102(e) against the appellant.

It is argued that "the invention described and claimed in the Subject Application was conceived of before July, 25, 2002; was constructively reduced to practice before July 25, 2002, by the filing of the Taiwan Application; and was diligently reduced to constructive practice from before July 25, 2002, to the filing of the Provisional Application on March 20, 2003." to establish prior invention and, accordingly, disqualify Rodriguez et al. as prior art since Rodriguez's filing date was July 25, 2002.

Because the prohibition regarding relying on the filing date of an earlier foreign application which was more than one year from the filing date of a non-provisional application for patent under 35 USC 119(a), the affidavit may at best be sufficient to show conception as of the applicant's foreign filing date of February 4, 2002 but not adequate to establish constructive reduction to practice at least as early as February 4, 2002. As such, in order to disqualify Rodriguez et al. as a 102(e) reference, diligence must be shown from the date of conception to the filing date of the Rodriguez et al. reference. Examiner respectfully submits that, absent a showing of diligence, the evidence is insufficient to disqualify Rodriguez et al. as a 102(e) reference.

It is respectfully submitted that a foreign application, with which no priority benefit under 35 USC 119 could have been claimed in a subsequent US application that was filed more than one year from the filing date of the foreign application, cannot be relied on to establish a constructive reduction to practice. It is inoperative for any purpose, save as evidence of conception. In order to overcome a prior art reference under section 102(e) appellants must either satisfy the substantive requirements of Rule 131 or establish that the relevant disclosure describes their own invention. In establishing prior invention to overcome the Rodriguez et al. reference appellants cannot rely on their earlier filed Taiwan application as a constructive reduction to practice of the invention. The evidence presented by appellants is not sufficient to establish invention prior to the effective date of the reference under Rule 131. *In re Costello*, 717 F.2d 1346, 219 USPQ 389 (Fed. Cir. 1983).

### ***Conclusion***

6. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Johnson et al. (US 5,860,291) teaches that critical heat producing components are placed in proximity to the air inlets and to reduce the cooling of components that are insensitive to heat. Lau et al. (US 5,440,450), Nelson (US 5,691,883) and Dalheimer (US 6,618,248) teach a chassis with a fan and a plurality of air outlets directing an airflow first passing over the motherboard components (high heat – more heat critical) then the warmer air passing over the power supply components (low heat – less heat critical).

This is a Request for Continued Examination of applicant's earlier Application No. 10/767415. All claims are drawn to the same invention claimed in the earlier application and could have been finally rejected on the grounds and art of record in the next Office action if they had been entered in the earlier application. Accordingly, **THIS ACTION IS MADE FINAL** even though it is a first action in this case. See MPEP § 706.07(b). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no, however, event will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Robert J. Hoffberg whose telephone number is (571) 272-2761. The examiner can normally be reached on 8:30 AM - 4:30 PM Mon - Fri.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Lynn D. Feild can be reached on (571) 272-2092. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.



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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

RJH *EAH*

*Lynn Feild*  
**LYNN FEILD  
SUPERVISORY PATENT EXAMINER**